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Surface modification of polyether ether ketone (peek) films for flexible printed circuit boards

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| CALENDAR OF EVENTS

June 10–14, 2002, Short Course: Composite Materials Technology, University of Surrey, Guildford, Surrey, UK. For information contact Derek Saunders, Manager of Continuing Education, School of Engineering, Post Bag H6, University of Surrey, Guildford GU2 7XH, UK. Tel.: +44 (0) 1483 689612; Fax: +44 (0) 1483 6866291; E-mail: d.saunders@surrey.ac.uk

July 22–26, 2002, Short Course: Surface Engineering, University of Surrey, Guildford, Surrey, UK. For information contact Derek Saunders, Manager of Continuing Education, School of Engineering Post Bag H6, University of Surrey, Guildford GU2 7XH, UK. Tel.: +44 (0) 1483 689612; Fax: +44 (0) 1483 6866291; E-mail: d.saunders@surrey.ac.uk

August 8–13, 2002, The Ninth International Conference on Composite Interfaces, Huaqiao University, Quanzhou, Fujian Province, China. Sponsored by Nanjing University, Shanghai Jiaotong University and Huaqiao University, China on behalf of the International Composite Society and Composite Society of China, supported by The National Science Foundation of China and Science and Technology Bureau of Fujian Province, China. For information contact Dr. Gending Ji, General Conference Secretary, ICCI-IX, Research Center of Surface & Interface Chemistry and Engineering Technology, Nanjing University, China, 210093. Fax: +86-25-3594404; E-mail: gj19@cornell.edu

September 10–13, 2002, EURADH 2002, 6th European Adhesion Conference, 8th International Conference on the Science & Technology of Adhesion and Adhesives, University of Strathclyde, Glasgow, UK. For information contact Lisa Bromley, Conference & Events (C0207), IOM Communications Ltd, 1 Carlton House Terrace, London SW1Y 5DB, UK. Tel.: +44 (0)20 7451 7302; Fax: +44 (0)20 7839 2289; E-mail: lisa_bromley@materials.org.uk; Web Site: www.materials.org.uk/iomevents/EurAdh

November 20–21, 2002, A Symposium in Memory of Dr. Bernie Miller, Sponsored by TRI/Princeton and to be held at the Conference Center at the New Jersey Hospital Association, 760 Alexander Road, Princeton, NJ. For information contact Eleanor Lehman, TRI/Princeton, P.O. Box 625, Princeton, NJ 08542-0625. Tel.: 609-430-4820; Fax: 609-683-7149; E-mail: info@triprinceton.org; Web Site: <http://www.triprinceton.org/miller>

January 29–30, 2003, Symposium on Durability of Building and Construction Sealants and Adhesives (2003-DBCSEA), sponsored by ASTM Committee C24 on Building Seals and Sealants, Ft. Lauderdale, Florida, USA. For information contact Andreas Wolf, Dow Corning S.A., Parc Industriel, B-7180 Seneffe, Belgium. Tel.: +32 (0) 64 888 950; Fax: +32 (0) 64 888.177; E-mail: andreas.wolf@dowcorning.com

February 23–26, 2003, Call for papers for the 26th Annual Meeting of The Adhesion Society, Inc. Submission of papers is requested for this meeting, which will be held in Myrtle Beach, South Carolina, USA, 23–26 February, 2003. Guidelines for submission are as follows:

1. Abstracts of 200 words or less will be accepted until 2 August 2002
2. Contributed papers will be accepted in all areas of adhesion and related phenomena
3. Papers will be presented in oral and poster sessions. The program chairs, in consultation with the principal authors, will determine the manner of presentation
4. Four parallel sessions each day will be organized for the oral presentations and two poster sessions will be arranged to accommodate the poster paper presentations

Submission of Abstracts. Send 200 word abstracts electronically in Microsoft compatible format via e-mail to adhesoc@vt.edu by August 2, 2002. Abstracts can also be submitted to the Home Office of the Society via Fax or regular mail; however, electronic submission is preferred. Include the following information:

Title

Author(s) and affiliation(s)

Principal author's mailing address, telephone, fax, and e-mail address

Research objectives
Approach
Relevance to adhesion
Results

Important Dates:

2 August 2003: Abstracts must be received by the Adhesion Society
21–22 February 2003: Short Course, “Adhesion: Theory and Practice”
23–26 February 2003: Adhesion Society 26th Annual Meeting

The mailing address of the Adhesion Society’s Home Office is: 2110 Hahn Hall—0344, Blacksburg, VA 24061, USA. Tel. 540-231-7257; Fax 540-231-8517; E-mail: adhsoc@vt.edu

February 24–26, 2003, SME Annual Meeting, Symposium on Functional Fillers and Nanoscale Minerals, Cincinnati, Ohio, USA. Papers are solicited for all of the sessions listed below:

1. Functional Mineral Filler Fundamentals—General Session, Session Chair: Vas Veeramasuneni
2. Purification, Synthesis, Modification, and Characterization of Fillers and Nanofillers, Session Chair: Dr. Cesar Basilio
3. Filled Systems, Dispersion, and Compounding, Session Chair: Dr. Courtney Young
4. Surface Modification, Matrix Interactions, Interfaces, and Adhesion, Session Chair: Dr. Jaroslaw Drelich
5. Effects of Fillers on Mechanical, Electrical, Thermal Stability and other Properties, Session Chair: Dr. Jon J. Kellar.

Preliminary titles and (up to half-page) abstracts are due by February 1, 2002, and should be sent via E-mail directly to Professor Jon Kellar, Chairman of the Symposium, at: jkellar@silver.sdsmt.edu or to Professor Jaroslaw Drelich at: jwdrelic@mtu.edu